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(Use as many sheets as necessary)			
Sheet	1	of	1
		Application Number 09/753,863	
		Filing Date January 3, 2001	
		First Named Inventor MELICK, et al.	
		Art Unit 2876	
		Examiner Name TBA - FILE	
		Attorney Docket Number P05220US0	

U.S. PATENT DOCUMENTS

FOREIGN PATENT DOCUMENTS

Examiner Signature	ITLE	Date Considered	4/14/2028
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